# **Power MOSFET** 40 V, 3 mΩ, 107 A, Single N–Channel

#### Features

- Small Footprint (3.3x3.3 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS	$(T_{J} = 25^{\circ})$	C unless otherv	vise noted)			
Parar	neter		Symbol	Value	Unit	
Drain-to-Source Voltag	е		V <sub>DSS</sub>	40	V	
Gate-to-Source Voltage	Э		V <sub>GS</sub>	±20	V	
Continuous Drain Current R <sub>θJC</sub>		$T_C = 25^{\circ}C$	I <sub>D</sub>	107	Α	
(Notes 1, 3)	Steady	T <sub>C</sub> = 100°C		75	1	
Power Dissipation	State	T <sub>C</sub> = 25°C	PD	68	V V A W A W A V V A O °C	
R <sub>θJC</sub> (Note 1)		$T_{C} = 100^{\circ}C$		34		
Continuous Drain		T <sub>A</sub> = 25°C	Ι <sub>D</sub>	23	Α	
Current R <sub>0JA</sub> (Notes 1, 2, 3)	Steady State	T <sub>A</sub> = 100°C		16		
Power Dissipation		$T_A = 25^{\circ}C$	PD	3.3	W	
R <sub>θJA</sub> (Notes 1 & 2)		$T_A = 100^{\circ}C$		1.6		
Pulsed Drain Current	T <sub>A</sub> = 25	°C, t <sub>p</sub> = 10 μs	I <sub>DM</sub>	740	А	
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>stg</sub>	–55 to +175	°C	
Source Current (Body D	۱ <sub>S</sub>	76	А			
Single Pulse Drain-to-S Energy (I <sub>L(pk)</sub> = 7 A)	Source Av	alanche	E <sub>AS</sub>	215	mJ	
Lead Temperature for S (1/8" from case for 10 s)		Purposes	ΤL	260	°C	

**MAXIMUM RATINGS** (T<sub>1</sub> = 25°C unless otherwise noted

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	2.2	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\thetaJA}$	46	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

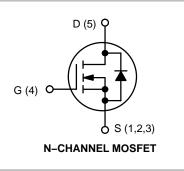
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

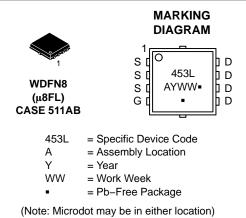


# **ON Semiconductor®**

#### www.onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
40 V	3 mΩ @ 10 V	107.4
40 V	4.8 mΩ @ 4.5 V	107 A





#### **ORDERING INFORMATION**

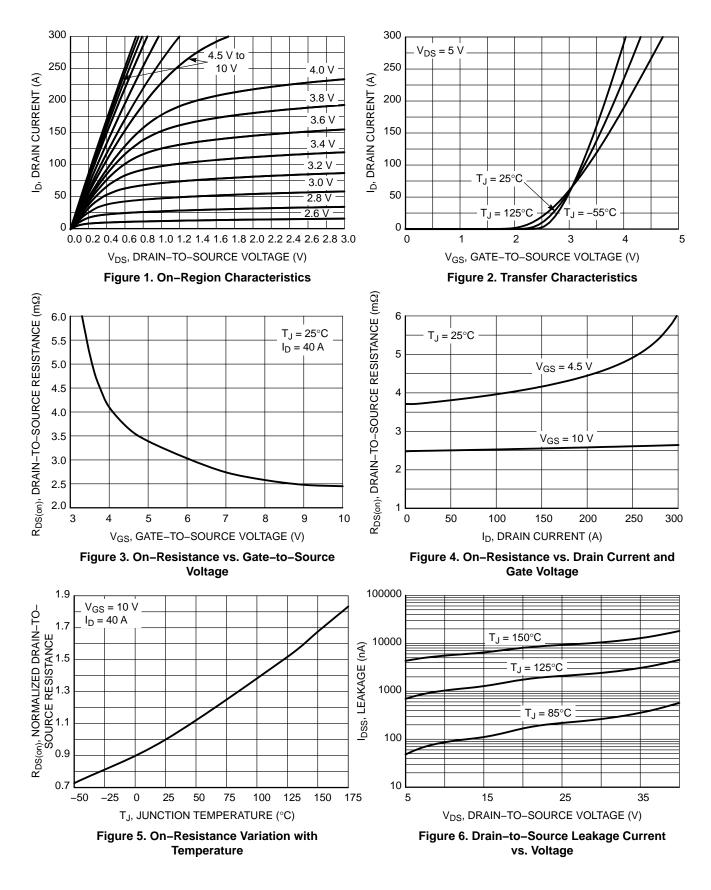
See detailed ordering, marking and shipping information on page 5 of this data sheet.

## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

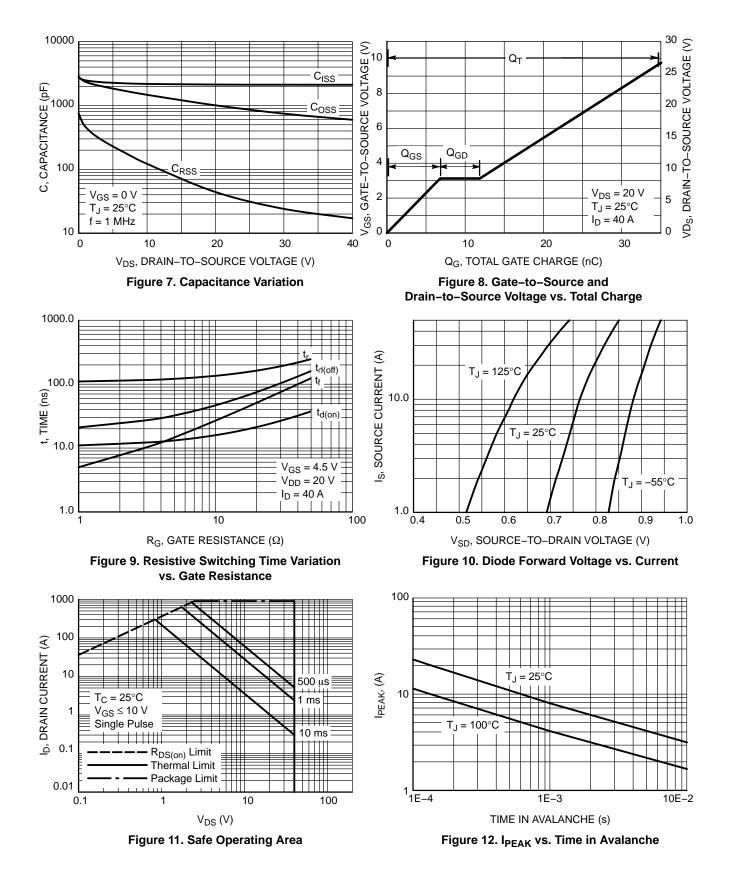
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				1.6		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V,$	T <sub>J</sub> = 25 °C			10	
		$V_{DS} = 40 V$	T <sub>J</sub> = 125°C			250	μΑ
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS}$	<sub>S</sub> = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_{D}$	= 60 μA	1.2	1.65	2.0	V
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				-5.3		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 40 A		2.5	3	
		$V_{GS}$ = 4.5 V	I <sub>D</sub> = 40 A		3.8	4.8	mΩ
Forward Transconductance	9fs	V <sub>DS</sub> = 15 V, I <sub>I</sub>	<sub>D</sub> = 40 A		120		S
CHARGES AND CAPACITANCES							
Input Capacitance	C <sub>ISS</sub>				2100		
Output Capacitance	C <sub>OSS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 25 V			1000		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>				42		1
Output Charge	Q <sub>OSS</sub>	$V_{GS} = 0 V, V_D$	<sub>D</sub> = 20 V		31		nC
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 2	20 V; I <sub>D</sub> = 40 A		35		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 20 V; I <sub>D</sub> = 40 A			16		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>				4.0		
Gate-to-Source Charge	Q <sub>GS</sub>				7.0		
Gate-to-Drain Charge	Q <sub>GD</sub>				5.0		1
Plateau Voltage	V <sub>GP</sub>				3.2		V
Gate Resistance	R <sub>G</sub>	T <sub>A</sub> = 25	°C		1.2		Ω
SWITCHING CHARACTERISTICS (Note 5	5)						
Turn-On Delay Time	t <sub>d(ON)</sub>				11		
Rise Time	t <sub>r</sub>	$V_{GS}$ = 4.5 V, $V_{DS}$ = 20 V, I <sub>D</sub> = 40 A, R <sub>G</sub> = 2.5 $\Omega$			110		ns
Turn-Off Delay Time	t <sub>d(OFF)</sub>				21		
Fall Time	t <sub>f</sub>				5		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS} = 0 V$ , $T_{J} = 25^{\circ}C$		0.84	1.2		
		V <sub>GS</sub> = 0 V, I <sub>S</sub> = 40 A	T <sub>J</sub> = 125°C		0.72		V
Reverse Recovery Time	t <sub>RR</sub>				41		1
Charge Time	t <sub>a</sub>	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt	= 100 A/us		19		ns
Discharge Time	t <sub>b</sub>	$I_{\rm S} = 40$	Α		22		
Reverse Recovery Charge	Q <sub>RR</sub>	1			30		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Pulse Test: pulse width ≤ 300 µs, duty cycle ≤ 2%.
5. Switching characteristics are independent of operating junction temperatures.

### **TYPICAL CHARACTERISTICS**



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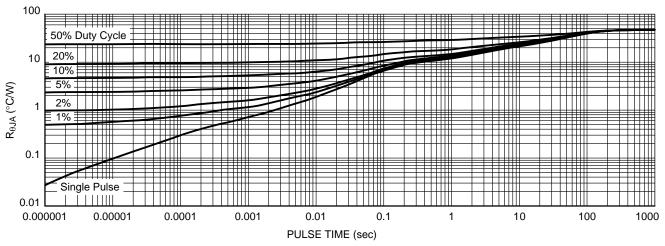


Figure 13. Thermal Characteristics

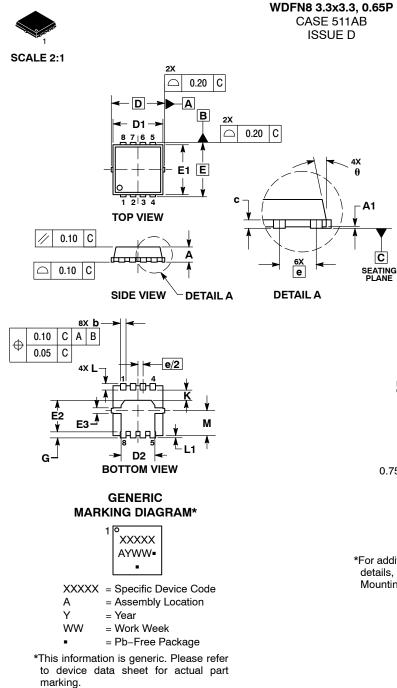
#### **DEVICE ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NTTFS5C453NLTAG	453L	WDFN8 (Pb–Free)	1500 / Tape & Reel
NTTFS5C453NLTWG	453L	WDFN8 (Pb–Free)	5000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

DATE 23 APR 2012





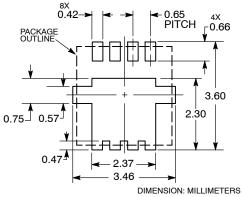
Pb-Free indicator, "G" or microdot " .", may or may not be present.

NOTES: LES: DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS. 1.

2. 3.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.70	0.75	0.80	0.028	0.030	0.031	
A1	0.00		0.05	0.000		0.002	
b	0.23	0.30	0.40	0.009	0.012	0.016	
с	0.15	0.20	0.25	0.006	0.008	0.010	
D		3.30 BSC		0	.130 BSC	)	
D1	2.95	3.05	3.15	0.116	0.120	0.124	
D2	1.98	2.11	2.24	0.078	0.083	0.088	
E	3.30 BSC			0.130 BSC			
E1	2.95	3.05	3.15	0.116	0.120	0.124	
E2	1.47	1.60	1.73	0.058	0.063	0.068	
E3	0.23	0.30	0.40	0.009	0.012	0.016	
е		0.65 BSC		(	0.026 BS0	2	
G	0.30	0.41	0.51	0.012	0.016	0.020	
к	0.65	0.80	0.95	0.026	0.032	0.037	
L	0.30	0.43	0.56	0.012	0.017	0.022	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
м	1.40	1.50	1.60	0.055	0.059	0.063	
θ	0 °		12 °	0 °		12 °	

SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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